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Intel - 5SGXEA5H2F35C3N Datasheet



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Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| Product Status | Obsolete |
|--------------------------------|--|
| Number of LABs/CLBs | 185000 |
| Number of Logic Elements/Cells | 490000 |
| Total RAM Bits | 46080000 |
| Number of I/O | 552 |
| Number of Gates | - |
| Voltage - Supply | 0.82V ~ 0.88V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 1152-BBGA, FCBGA |
| Supplier Device Package | 1152-FBGA (35x35) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgxea5h2f35c3n |
| | |

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This section lists the functional operating limits for the AC and DC parameters for Stratix V devices. Table 6 lists the steady-state voltage and current values expected from Stratix V devices. Power supply ramps must all be strictly monotonic, without plateaus.

Table 6. Recommended Operating Conditions for Stratix V Devices (Part 1 of 2)

| Symbol | Description | Condition | Min ⁽⁴⁾ | Тур | Max ⁽⁴⁾ | Unit |
|----------------------------------|---|------------|--------------------|------|--------------------|------|
| | Core voltage and periphery circuitry power supply (C1, C2, I2, and I3YY speed grades) | _ | 0.87 | 0.9 | 0.93 | V |
| V _{CC} | Core voltage and periphery circuitry power supply (C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) ⁽³⁾ | _ | 0.82 | 0.85 | 0.88 | V |
| V _{CCPT} | Power supply for programmable power technology | _ | 1.45 | 1.50 | 1.55 | V |
| V _{CC_AUX} | Auxiliary supply for the programmable power technology | _ | 2.375 | 2.5 | 2.625 | V |
| VI (1) | I/O pre-driver (3.0 V) power supply | _ | 2.85 | 3.0 | 3.15 | V |
| V _{CCPD} ⁽¹⁾ | I/O pre-driver (2.5 V) power supply | _ | 2.375 | 2.5 | 2.625 | V |
| | I/O buffers (3.0 V) power supply | | 2.85 | 3.0 | 3.15 | V |
| | I/O buffers (2.5 V) power supply | _ | 2.375 | 2.5 | 2.625 | V |
| | I/O buffers (1.8 V) power supply | | 1.71 | 1.8 | 1.89 | V |
| V _{CCIO} | I/O buffers (1.5 V) power supply | _ | 1.425 | 1.5 | 1.575 | V |
| | I/O buffers (1.35 V) power supply | _ | 1.283 | 1.35 | 1.45 | V |
| | I/O buffers (1.25 V) power supply | _ | 1.19 | 1.25 | 1.31 | V |
| | I/O buffers (1.2 V) power supply | _ | 1.14 | 1.2 | 1.26 | V |
| | Configuration pins (3.0 V) power supply | _ | 2.85 | 3.0 | 3.15 | V |
| V _{CCPGM} | Configuration pins (2.5 V) power supply | _ | 2.375 | 2.5 | 2.625 | V |
| | Configuration pins (1.8 V) power supply | _ | 1.71 | 1.8 | 1.89 | V |
| V _{CCA_FPLL} | PLL analog voltage regulator power supply | _ | 2.375 | 2.5 | 2.625 | V |
| V _{CCD_FPLL} | PLL digital voltage regulator power supply | _ | 1.45 | 1.5 | 1.55 | V |
| V _{CCBAT} (2) | Battery back-up power supply (For design security volatile key register) | _ | 1.2 | _ | 3.0 | V |
| VI | DC input voltage | _ | -0.5 | _ | 3.6 | V |
| V ₀ | Output voltage | — | 0 | — | V _{CCIO} | V |
| т | Operating junction temperature | Commercial | 0 | — | 85 | °C |
| TJ | Operating junction temperature | Industrial | -40 | _ | 100 | °C |

| Symbol | Description | Devices | Minimum ⁽⁴⁾ | Typical | Maximum ⁽⁴⁾ | Unit |
|-----------------------|--|----------------------|------------------------|---------|------------------------|------|
| | | | 0.82 | 0.85 | 0.88 | |
| V _{CCR_GXBR} | Dessiver apples never eventy (right side) | GX, GS, GT | 0.87 | 0.90 | 0.93 | v |
| (2) | Receiver analog power supply (right side) | un, us, ui | 0.97 | 1.0 | 1.03 | v |
| | | | 1.03 | 1.05 | 1.07 | |
| V _{CCR_GTBR} | Receiver analog power supply for GT channels (right side) | GT | 1.02 | 1.05 | 1.08 | V |
| | | | 0.82 | 0.85 | 0.88 | |
| V _{CCT_GXBL} | GXBL Transmitter analog power supply (left side) | GX, GS, GT | 0.87 | 0.90 | 0.93 | V |
| (2) | | | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 1.07 | |
| | | | 0.82 | 0.85 | 0.88 | |
| V _{CCT_GXBR} | Transmitter analog neuror cumply (right cide) | ght side) GX, GS, GT | 0.87 | 0.90 | 0.93 | v |
| (2) | Transmitter analog power supply (right side) | | 0.97 | 1.0 | 1.03 | v |
| | | | 1.03 | 1.05 | 1.07 | |
| V _{CCT_GTBR} | Transmitter analog power supply for GT channels (right side) | GT | 1.02 | 1.05 | 1.08 | V |
| V_{CCL_GTBR} | Transmitter clock network power supply | GT | 1.02 | 1.05 | 1.08 | V |
| V _{CCH_GXBL} | Transmitter output buffer power supply (left side) | GX, GS, GT | 1.425 | 1.5 | 1.575 | V |
| V _{CCH_GXBR} | Transmitter output buffer power supply (right side) | GX, GS, GT | 1.425 | 1.5 | 1.575 | V |

| Table 7. | Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, | GS, and GT Devices |
|----------|---|--------------------|
| (Part 2 | of 2) | |

Notes to Table 7:

(1) This supply must be connected to 3.0 V if the CMU PLL, receiver CDR, or both, are configured at a base data rate > 6.5 Gbps. Up to 6.5 Gbps, you can connect this supply to either 3.0 V or 2.5 V.

(2) Refer to Table 8 to select the correct power supply level for your design.

(3) When using ATX PLLs, the supply must be 3.0 V.

(4) This value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Internal Weak Pull-Up Resistor

Table 16 lists the weak pull-up resistor values for Stratix V devices.

| Symbol | Description | V _{CCIO} Conditions (V) ⁽³⁾ | Value ⁽⁴⁾ | Unit |
|-----------------|---|--|----------------------|------|
| | | 3.0 ±5% | 25 | kΩ |
| | | 2.5 ±5% | 25 | kΩ |
| | Value of the I/O pin pull-up resistor before | 1.8 ±5% | 25 | kΩ |
| R _{PU} | and during configuration, as well as user mode if you enable the programmable | 1.5 ±5% | 25 | kΩ |
| | pull-up resistor option. | 1.35 ±5% | 25 | kΩ |
| | | 1.25 ±5% | 25 | kΩ |
| | | 1.2 ±5% | 25 | kΩ |

Table 16. Internal Weak Pull-Up Resistor for Stratix V Devices (1), (2)

Notes to Table 16:

(1) All I/O pins have an option to enable the weak pull-up resistor except the configuration, test, and JTAG pins.

(2) The internal weak pull-down feature is only available for the JTAG TCK pin. The typical value for this internal weak pull-down resistor is approximately 25 k Ω .

- (3) The pin pull-up resistance values may be lower if an external source drives the pin higher than V_{CCIO}.
- (4) These specifications are valid with a $\pm 10\%$ tolerance to cover changes over PVT.

I/O Standard Specifications

Table 17 through Table 22 list the input voltage (V_{IH} and V_{IL}), output voltage (V_{OH} and V_{OL}), and current drive characteristics (I_{OH} and I_{OL}) for various I/O standards supported by Stratix V devices. These tables also show the Stratix V device family I/O standard specifications. The V_{OL} and V_{OH} values are valid at the corresponding I_{OH} and I_{OL}, respectively.

For an explanation of the terms used in Table 17 through Table 22, refer to "Glossary" on page 65. For tolerance calculations across all SSTL and HSTL I/O standards, refer to Altera knowledge base solution rd07262012_486.

| I/O | | V _{ccio} (V) | | V | L (V) | VIH | (V) | V _{OL} (V) | V _{OH} (V) | IOL | I _{oh} |
|----------|-------|-----------------------|-------|------|-----------------------------|-----------------------------|-------------------------|-----------------------------|-----------------------------|------|-----------------|
| Standard | Min | Тур | Max | Min | Max | Min | Max | Max | Min | (mĀ) | (mÅ) |
| LVTTL | 2.85 | 3 | 3.15 | -0.3 | 0.8 | 1.7 | 3.6 | 0.4 | 2.4 | 2 | -2 |
| LVCMOS | 2.85 | 3 | 3.15 | -0.3 | 0.8 | 1.7 | 3.6 | 0.2 | $V_{CCI0} - 0.2$ | 0.1 | -0.1 |
| 2.5 V | 2.375 | 2.5 | 2.625 | -0.3 | 0.7 | 1.7 | 3.6 | 0.4 | 2 | 1 | -1 |
| 1.8 V | 1.71 | 1.8 | 1.89 | -0.3 | 0.35 * V _{CCI0} | 0.65 * V _{CCI0} | V _{CCI0} + 0.3 | 0.45 | V _{CCI0} – 0.45 | 2 | -2 |
| 1.5 V | 1.425 | 1.5 | 1.575 | -0.3 | 0.35 * V _{CCI0} | 0.65 * V _{CCI0} | V _{CCI0} + 0.3 | 0.25 * V _{CCI0} | 0.75 * V _{CCIO} | 2 | -2 |
| 1.2 V | 1.14 | 1.2 | 1.26 | -0.3 | 0.35 * V _{CCI0} | 0.65 * V _{CCIO} | V _{CCI0} + 0.3 | 0.25 * V _{CCI0} | 0.75 * V _{CCI0} | 2 | -2 |

Table 17. Single-Ended I/O Standards for Stratix V Devices

Table 24 shows the maximum transmitter data rate for the clock network.

Table 24. Clock Network Maximum Data Rate Transmitter Specifications (1)

| | ATX PLL | | | | CMU PLL ⁽²⁾ | | | fPLL | | |
|-----------------------------------|----------------------------------|--------------------------|--|----------------------------------|--------------------------|-------------------------------|----------------------------------|--------------------------|-------------------------------|--|
| Clock Network | Non- bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span | Non- bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span | Non- bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span | |
| x1 ⁽³⁾ | 14.1 | — | 6 | 12.5 | _ | 6 | 3.125 | _ | 3 | |
| x6 ⁽³⁾ | _ | 14.1 | 6 | _ | 12.5 | 6 | _ | 3.125 | 6 | |
| x6 PLL Feedback ⁽⁴⁾ | _ | 14.1 | Side- wide | _ | 12.5 | Side- wide | | _ | _ | |
| xN (PCIe) | _ | 8.0 | 8 | _ | 5.0 | 8 | _ | _ | _ | |
| VN (Native DHV ID) | 8.0 | 8.0 | Up to 13 channels above and below PLL | 7.99 | 7.99 | Up to 13 channels above | 3.125 | 3.125 | Up to 13 channels above | |
| xN (Native PHY IP) | _ | 8.01 to 9.8304 | Up to 7 channels above and below PLL | 7.55 | 7.55 | and below PLL | 3.120 | 0.120 | and below PLL | |

Notes to Table 24:

(1) Valid data rates below the maximum specified in this table depend on the reference clock frequency and the PLL counter settings. Check the MegaWizard message during the PHY IP instantiation.

(2) ATX PLL is recommended at 8 Gbps and above data rates for improved jitter performance.

(3) Channel span is within a transceiver bank.

(4) Side-wide channel bonding is allowed up to the maximum supported by the PHY IP.

| Symbol/ | Conditions | Conditions Transceiver Speed Grade 2 | | | s | Unit | | |
|--|--|---|---------------|--------------|--------------------------|-------------|--------------|-----------|
| Description | | Min | Тур | Max | Min | Тур | Max | |
| Reference Clock | | | | | | | | |
| Supported I/O Standards | Dedicated reference clock pin | 1.2-V PCN | /IL, 1.4-V PC | ML, 1.5-V P | CML, 2.5-V and HCSL | PCML, Diffe | rential LVPE | ECL, LVDS |
| | RX reference clock pin | | 1.4-V PCML | ., 1.5-V PCN | IL, 2.5-V PC | ML, LVPEC | L, and LVDS | 6 |
| Input Reference Clock Frequency (CMU PLL) ⁽⁶⁾ | _ | 40 | _ | 710 | 40 | _ | 710 | MHz |
| Input Reference Clock Frequency (ATX PLL) ⁽⁶⁾ | _ | 100 | - | 710 | 100 | _ | 710 | MHz |
| Rise time | 20% to 80% | | _ | 400 | | — | 400 | |
| Fall time | 80% to 20% | | | 400 | — | | 400 | ps |
| Duty cycle | — | 45 | | 55 | 45 | | 55 | % |
| Spread-spectrum modulating clock frequency | PCI Express (PCIe) | 30 | _ | 33 | 30 | _ | 33 | kHz |
| Spread-spectrum downspread | PCle | _ | 0 to -0.5 | | _ | 0 to -0.5 | _ | % |
| On-chip termination resistors ⁽¹⁹⁾ | _ | _ | 100 | _ | _ | 100 | _ | Ω |
| Absolute V _{MAX} ⁽³⁾ | Dedicated reference clock pin | | _ | 1.6 | _ | _ | 1.6 | V |
| | RX reference clock pin | _ | _ | 1.2 | _ | _ | 1.2 | |
| Absolute V _{MIN} | — | -0.4 | — | — | -0.4 | — | — | V |
| Peak-to-peak differential input voltage | _ | 200 | | 1600 | 200 | _ | 1600 | mV |
| V _{ICM} (AC coupled) | Dedicated reference clock pin | | 1050/1000 (| 2) | 1050/1000 ⁽²⁾ | | | mV |
| | RX reference clock pin | 1 | .0/0.9/0.85 (| 22) | 1.0/0.9/0.85 (22) | | | V |
| V _{ICM} (DC coupled) | HCSL I/O standard for PCIe reference clock | 250 | _ | 550 | 250 | _ | 550 | mV |

Table 28. Transceiver Specifications for Stratix V GT Devices (Part 1 of 5) ⁽¹⁾

| Table 28. Transceiver Specifications for Stratix V GT Devices (Part 5 of 5) (| Fransceiver Specifications for Stratix V GT Devices (Part 5 of 5) ⁽¹⁾ |
|---|--|
|---|--|

| Symbol/ Description | Conditions | | Transceivei peed Grade | | | Fransceive Deed Grade | | Unit |
|---------------------------------------|------------|-----|---------------------------|-----|-----|--------------------------|-----|------|
| Description | | Min | Тур | Max | Min | Тур | Max | |
| t _{pll_lock} ⁽¹⁴⁾ | — | — | _ | 10 | — | — | 10 | μs |

Notes to Table 28:

- (1) Speed grades shown refer to the PMA Speed Grade in the device ordering code. The maximum data rate could be restricted by the Core/PCS speed grade. Contact your Altera Sales Representative for the maximum data rate specifications in each speed grade combination offered. For more information about device ordering codes, refer to the Stratix V Device Overview.
- (2) The reference clock common mode voltage is equal to the VCCR_GXB power supply level.
- (3) The device cannot tolerate prolonged operation at this absolute maximum.
- (4) The differential eye opening specification at the receiver input pins assumes that receiver equalization is disabled. If you enable receiver equalization, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level.
- (5) Refer to Figure 5 for the GT channel AC gain curves. The total effective AC gain is the AC gain minus the DC gain.
- (6) Refer to Figure 6 for the GT channel DC gain curves.
- (7) CFP2 optical modules require the host interface to have the receiver data pins differentially terminated with 100 Ω. The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (8) Specifications for this parameter are the same as for Stratix V GX and GS devices. See Table 23 for specifications.
- (9) t_{1 TR} is the time required for the receive CDR to lock to the input reference clock frequency after coming out of reset.
- (10) t_{LTD} is time required for the receiver CDR to start recovering valid data after the rx is lockedtodata signal goes high.
- (11) t_{LTD_manual} is the time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high when the CDR is functioning in the manual mode.
- (12) t_{LTR_LTD_manual} is the time the receiver CDR must be kept in lock to reference (LTR) mode after the rx_is_lockedtoref signal goes high when the CDR is functioning in the manual mode.
- (13) tpll_powerdown is the PLL powerdown minimum pulse width.
- (14) tpll lock is the time required for the transmitter CMU/ATX PLL to lock to the input reference clock frequency after coming out of reset.
- (15) To calculate the REFCLK rms phase jitter requirement for PCle at reference clock frequencies other than 100 MHz, use the following formula: REFCLK rms phase jitter at f(MHz) = REFCLK rms phase jitter at 100 MHz × 100/f.
- (16) The maximum peak to peak differential input voltage V_{ID} after device configuration is equal to 4 × (absolute V_{MAX} for receiver pin V_{ICM}).
- (17) For ES devices, RREF is 2000 $\Omega \pm 1\%$.
- (18) To calculate the REFCLK phase noise requirement at frequencies other than 622 MHz, use the following formula: REFCLK phase noise at f(MHz) = REFCLK phase noise at 622 MHz + 20*log(f/622).
- (19) SFP/+ optical modules require the host interface to have RD+/- differentially terminated with 100 Ω. The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (20) Refer to Figure 4.
- (21) For oversampling design to support data rates less than the minimum specification, the CDR needs to be in LTR mode only.
- (22) This supply follows VCCR_GXB for both GX and GT channels.
- (23) When you use fPLL as a TXPLL of the transceiver.

Table 29 shows the V_{OD} settings for the GT channel.

| Table 29. | Typical Von Setting | g for GT Channel, T | EX Termination = 100 Ω |
|-----------|---------------------|---------------------|--------------------------------------|
|-----------|---------------------|---------------------|--------------------------------------|

| Symbol | V _{OD} Setting | V _{op} Value (mV) |
|---|-------------------------|----------------------------|
| | 0 | 0 |
| | 1 | 200 |
| \mathbf{V}_{0D} differential peak to peak typical (1) | 2 | 400 |
| VOD unicicilitat peak to peak typical (*) | 3 | 600 |
| | 4 | 800 |
| | 5 | 1000 |

Note:

(1) Refer to Figure 4.

PLL Specifications

Table 31 lists the Stratix V PLL specifications when operating in both the commercial junction temperature range (0° to 85° C) and the industrial junction temperature range (-40° to 100° C).

Table 31. PLL Specifications for Stratix V Devices (Part 1 of 3)

| Symbol | Parameter | Min | Тур | Max | Unit |
|--------------------------|--|-----|-----|--------------------|------|
| | Input clock frequency (C1, C2, C2L, I2, and I2L speed grades) | 5 | _ | 800 (1) | MHz |
| f _{IN} | Input clock frequency (C3, I3, I3L, and I3YY speed grades) | 5 | _ | 800 (1) | MHz |
| | Input clock frequency (C4, I4 speed grades) | 5 | _ | 650 ⁽¹⁾ | MHz |
| f _{INPFD} | Input frequency to the PFD | 5 | — | 325 | MHz |
| f _{finpfd} | Fractional Input clock frequency to the PFD | 50 | — | 160 | MHz |
| | PLL VCO operating range (C1, C2, C2L, I2, I2L speed grades) | 600 | _ | 1600 | MHz |
| f _{VCO} | PLL VCO operating range (C3, I3, I3L, I3YY speed grades) | 600 | _ | 1600 | MHz |
| | PLL VCO operating range (C4, I4 speed grades) | 600 | — | 1300 | MHz |
| t _{einduty} | Input clock or external feedback clock input duty cycle | 40 | | 60 | % |
| | Output frequency for an internal global or regional clock (C1, C2, C2L, I2, I2L speed grades) | — | _ | 717 ⁽²⁾ | MHz |
| f _{out} | Output frequency for an internal global or regional clock (C3, I3, I3L speed grades) | _ | _ | 650 ⁽²⁾ | MHz |
| | Output frequency for an internal global or regional clock (C4, I4 speed grades) | _ | _ | 580 ⁽²⁾ | MHz |
| | Output frequency for an external clock output (C1, C2, C2L, I2, I2L speed grades) | _ | _ | 800 (2) | MHz |
| f _{out_ext} | Output frequency for an external clock output (C3, I3, I3L speed grades) | _ | _ | 667 ⁽²⁾ | MHz |
| | Output frequency for an external clock output (C4, I4 speed grades) | _ | _ | 553 ⁽²⁾ | MHz |
| t _{outduty} | Duty cycle for a dedicated external clock output (when set to 50%) | 45 | 50 | 55 | % |
| t _{FCOMP} | External feedback clock compensation time | _ | — | 10 | ns |
| f _{dyconfigclk} | Dynamic Configuration Clock used for <code>mgmt_clk</code> and <code>scanclk</code> | _ | _ | 100 | MHz |
| t _{LOCK} | Time required to lock from the end-of-device configuration or deassertion of areset | _ | _ | 1 | ms |
| t _{olock} | Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays) | _ | _ | 1 | ms |
| | PLL closed-loop low bandwidth | | 0.3 | — | MHz |
| f _{CLBW} | PLL closed-loop medium bandwidth | _ | 1.5 | | MHz |
| | PLL closed-loop high bandwidth (7) | | 4 | — | MHz |
| t _{PLL_PSERR} | Accuracy of PLL phase shift | | | ±50 | ps |
| t _{areset} | Minimum pulse width on the areset signal | 10 | _ | | ns |

Table 31. PLL Specifications for Stratix V Devices (Part 3 of 3)

| Symbol | Parameter | Min | Тур | Max | Unit |
|------------------|---|--------|------|-------|------|
| f _{RES} | Resolution of VCO frequency ($f_{INPFD} = 100 \text{ MHz}$) | 390625 | 5.96 | 0.023 | Hz |

Notes to Table 31:

(1) This specification is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.

(2) This specification is limited by the lower of the two: I/O f_{MAX} or f_{OUT} of the PLL.

- (3) A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source < 120 ps.
- (4) f_{REF} is fIN/N when N = 1.
- (5) Peak-to-peak jitter with a probability level of 10⁻¹² (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in Table 44 on page 52.
- (6) The cascaded PLL specification is only applicable with the following condition: a. Upstream PLL: 0.59Mhz ≤ Upstream PLL BW < 1 MHz b. Downstream PLL: Downstream PLL BW > 2 MHz
- (7) High bandwidth PLL settings are not supported in external feedback mode.
- (8) The external memory interface clock output jitter specifications use a different measurement method, which is available in Table 42 on page 50.
- (9) The VCO frequency reported by the Quartus II software in the PLL Usage Summary section of the compilation report takes into consideration the VCO post-scale counter K value. Therefore, if the counter K has a value of 2, the frequency reported can be lower than the f_{VCO} specification.
- (10) This specification only covers fractional PLL for low bandwidth. The f_{VCO} for fractional value range 0.05 0.95 must be \geq 1000 MHz, while f_{VCO} for fractional value range 0.20 0.80 must be \geq 1200 MHz.
- (11) This specification only covered fractional PLL for low bandwidth. The f_{VC0} for fractional value range 0.05-0.95 must be \geq 1000 MHz.
- (12) This specification only covered fractional PLL for low bandwidth. The f_{VC0} for fractional value range 0.20-0.80 must be \geq 1200 MHz.

DSP Block Specifications

Table 32 lists the Stratix V DSP block performance specifications.

| | | | I | Peforman | ce | | | | |
|--|-----|---------|------------|----------|------------------|-----|-----|------|--|
| Mode | C1 | C2, C2L | 12, 12L | C3 | 13, 13L, 13YY | C4 | 14 | Unit | |
| | | Modes ι | ising one | DSP | | | | 4 | |
| Three 9 x 9 | 600 | 600 | 600 | 480 | 480 | 420 | 420 | MHz | |
| One 18 x 18 | 600 | 600 | 600 | 480 | 480 | 420 | 400 | MHz | |
| Two partial 18 x 18 (or 16 x 16) | 600 | 600 | 600 | 480 | 480 | 420 | 400 | MHz | |
| One 27 x 27 | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz | |
| One 36 x 18 | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz | |
| One sum of two 18 x 18(One sum of 2 16 x 16) | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz | |
| One sum of square | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz | |
| One 18 x 18 plus 36 (a x b) + c | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz | |
| | | Modes u | sing two l | DSPs | 1 | | • | 1 | |
| Three 18 x 18 | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz | |
| One sum of four 18 x 18 | 475 | 475 | 475 | 380 | 380 | 300 | 300 | MHz | |
| One sum of two 27 x 27 | 465 | 465 | 450 | 380 | 380 | 300 | 290 | MHz | |
| One sum of two 36 x 18 | 475 | 475 | 475 | 380 | 380 | 300 | 300 | MHz | |
| One complex 18 x 18 | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz | |
| One 36 x 36 | 475 | 475 | 475 | 380 | 380 | 300 | 300 | MHz | |

Table 32. Block Performance Specifications for Stratix V DSP Devices (Part 1 of 2)

| Speed Grade | Min | Max | Unit |
|-------------|-----|-----|------|
| C4,I4 | 8 | 16 | ps |

Table 40. DQS Phase Offset Delay Per Setting for Stratix V Devices ^{(1), (2)} (Part 2 of 2)

Notes to Table 40:

(1) The typical value equals the average of the minimum and maximum values.

(2) The delay settings are linear with a cumulative delay variation of 40 ps for all speed grades. For example, when using a -2 speed grade and applying a 10-phase offset setting to a 90° phase shift at 400 MHz, the expected average cumulative delay is [625 ps + (10 × 10 ps) ± 20 ps] = 725 ps ± 20 ps.

Table 41 lists the DQS phase shift error for Stratix V devices.

Table 41. DQS Phase Shift Error Specification for DLL-Delayed Clock (t_{DQS_PSERR}) for Stratix V Devices ⁽¹⁾

| Number of DQS Delay Buffers | C1 | C2, C2L, I2, I2L | C3, I3, I3L, I3YY | C4,14 | Unit |
|--------------------------------|-----|------------------|-------------------|-------|------|
| 1 | 28 | 28 | 30 | 32 | ps |
| 2 | 56 | 56 | 60 | 64 | ps |
| 3 | 84 | 84 | 90 | 96 | ps |
| 4 | 112 | 112 | 120 | 128 | ps |

Notes to Table 41:

(1) This error specification is the absolute maximum and minimum error. For example, skew on three DQS delay buffers in a -2 speed grade is ± 78 ps or ± 39 ps.

Table 42 lists the memory output clock jitter specifications for Stratix V devices.

| Clock Network | Parameter | Symbol | C | 1 C2, C2L, I2, I2L | | C3, I3, I3L, I3YY | | C4,14 | | Unit | |
|------------------|---------------------------------|-------------------------------|------|--------------------|------|----------------------|-------|-------|-------|------|----|
| | | - | Min | Max | Min | Max | Min | Max | Min | Max | |
| | Clock period jitter | $t_{JIT(per)}$ | -50 | 50 | -50 | 50 | -55 | 55 | -55 | 55 | ps |
| Regional | Cycle-to-cycle period jitter | $t_{\text{JIT(cc)}}$ | -100 | 100 | -100 | 100 | -110 | 110 | -110 | 110 | ps |
| | Duty cycle jitter | $t_{\text{JIT}(\text{duty})}$ | -50 | 50 | -50 | 50 | -82.5 | 82.5 | -82.5 | 82.5 | ps |
| | Clock period jitter | $t_{JIT(per)}$ | -75 | 75 | -75 | 75 | -82.5 | 82.5 | -82.5 | 82.5 | ps |
| Global | Cycle-to-cycle period jitter | $t_{\rm JIT(cc)}$ | -150 | 150 | -150 | 150 | -165 | 165 | -165 | 165 | ps |
| | Duty cycle jitter | $t_{JIT(duty)}$ | -75 | 75 | -75 | 75 | -90 | 90 | -90 | 90 | ps |

| Clock | Parameter | Symbol | C | 1 | C2, C2L | , 12 , 12L | C3, I3 I3 | | C4 | ,14 | Unit |
|--------------|---------------------------------|----------------------|-------|------|---------|--------------------------|--------------|-----|-----|-----|------|
| Network | rk | | Min | Max | Min | Max | Min | Max | Min | Max | |
| | Clock period jitter | $t_{JIT(per)}$ | -25 | 25 | -25 | 25 | -30 | 30 | -35 | 35 | ps |
| PHY Clock | Cycle-to-cycle period jitter | $t_{\text{JIT(cc)}}$ | -50 | 50 | -50 | 50 | -60 | 60 | -70 | 70 | ps |
| | Duty cycle jitter | $t_{JIT(duty)}$ | -37.5 | 37.5 | -37.5 | 37.5 | -45 | 45 | -56 | 56 | ps |

Table 42. Memory Output Clock Jitter Specification for Stratix V Devices (1), (Part 2 of 2) (2), (3)

Notes to Table 42:

(1) The clock jitter specification applies to the memory output clock pins generated using differential signal-splitter and DDIO circuits clocked by a PLL output routed on a PHY, regional, or global clock network as specified. Altera recommends using PHY clock networks whenever possible.

(2) The clock jitter specification applies to the memory output clock pins clocked by an integer PLL.

(3) The memory output clock jitter is applicable when an input jitter of 30 ps peak-to-peak is applied with bit error rate (BER) -12, equivalent to 14 sigma.

OCT Calibration Block Specifications

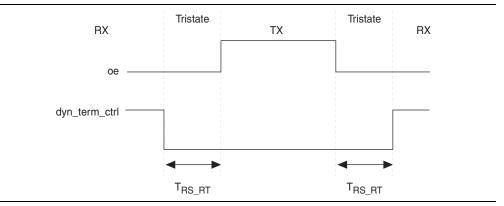
Table 43 lists the OCT calibration block specifications for Stratix V devices.

Table 43. OCT Calibration Block Specifications for Stratix V Devices

| Symbol | Description | Min | Тур | Max | Unit |
|-----------------------|---|-----|------|-----|--------|
| OCTUSRCLK | Clock required by the OCT calibration blocks | | _ | 20 | MHz |
| T _{OCTCAL} | Number of OCTUSRCLK clock cycles required for OCT $\rm R_S/R_T$ calibration | _ | 1000 | _ | Cycles |
| T _{OCTSHIFT} | Number of OCTUSRCLK clock cycles required for the OCT code to shift out | — | 32 | _ | Cycles |
| T _{RS_RT} | Time required between the dyn_term_ctrl and oe signal transitions in a bidirectional I/O buffer to dynamically switch between OCT R_S and R_T (Figure 10) | _ | 2.5 | | ns |

Figure 10 shows the timing diagram for the oe and dyn_term_ctrl signals.

Figure 10. Timing Diagram for oe and dyn_term_ctrl Signals



Duty Cycle Distortion (DCD) Specifications

Table 44 lists the worst-case DCD for Stratix V devices.

Table 44. Worst-Case DCD on Stratix V I/O Pins (1)

| Symbol | C | 1 | C2, C2 | L, 12, 12L | | 3, I3L, Syy | C4 | 4,14 | Unit |
|-------------------|-----|-----|--------|------------|-----|----------------|---------|------|------|
| | Min | Max | Min | Max | Min | Max | Min Max | | |
| Output Duty Cycle | 45 | 55 | 45 | 55 | 45 | 55 | 45 | 55 | % |

Note to Table 44:

(1) The DCD numbers do not cover the core clock network.

Configuration Specification

POR Delay Specification

Power-on reset (POR) delay is defined as the delay between the time when all the power supplies monitored by the POR circuitry reach the minimum recommended operating voltage to the time when the nSTATUS is released high and your device is ready to begin configuration.



For more information about the POR delay, refer to the *Hot Socketing and Power-On Reset in Stratix V Devices* chapter.

Table 45 lists the fast and standard POR delay specification.

Table 45. Fast and Standard POR Delay Specification (1)

| POR Delay | Minimum | Maximum |
|-----------|---------|---------|
| Fast | 4 ms | 12 ms |
| Standard | 100 ms | 300 ms |

Note to Table 45:

(1) You can select the POR delay based on the MSEL settings as described in the MSEL Pin Settings section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.

JTAG Configuration Specifications

Table 46 lists the JTAG timing parameters and values for Stratix V devices.

Table 46. JTAG Timing Parameters and Values for Stratix V Devices

| Symbol | Description | Min | Max | Unit |
|-------------------------|------------------------------------|-----|-----|------|
| t _{JCP} | TCK clock period ⁽²⁾ | 30 | — | ns |
| t _{JCP} | TCK clock period ⁽²⁾ | 167 | — | ns |
| t _{JCH} | TCK clock high time ⁽²⁾ | 14 | — | ns |
| t _{JCL} | TCK clock low time ⁽²⁾ | 14 | — | ns |
| t _{JPSU (TDI)} | TDI JTAG port setup time | 2 | — | ns |
| t _{JPSU (TMS)} | TMS JTAG port setup time | 3 | — | ns |

| Family | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) ^{(4), (5)} |
|----------------------------|--------|---------|--------------------------------|--|
| Strativ V E (1) | 5SEE9 | — | 342,742,976 | 700,888 |
| Stratix V E ⁽¹⁾ | 5SEEB | _ | 342,742,976 | 700,888 |

Table 47. Uncompressed .rbf Sizes for Stratix V Devices

Notes to Table 47:

(1) Stratix V E devices do not have PCI Express® (PCIe®) hard IP. Stratix V E devices do not support the CvP configuration scheme.

(2) 36-transceiver devices.

(3) 24-transceiver devices.

(4) File size for the periphery image.

(5) The IOCSR .rbf size is specifically for the CvP feature.

Use the data in Table 47 to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal (.hex) or tabular text file (.ttf) format, have different file sizes. For the different types of configuration file and file sizes, refer to the Quartus II software. However, for a specific version of the Quartus II software, any design targeted for the same device has the same uncompressed configuration file size. If you are using compression, the file size can vary after each compilation because the compression ratio depends on your design.

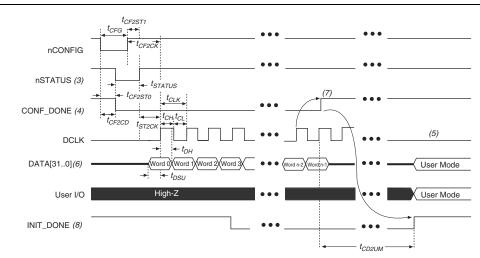
• For more information about setting device configuration options, refer to *Configuration, Design Security, and Remote System Upgrades in Stratix V Devices.* For creating configuration files, refer to the *Quartus II Help.*

Table 48 lists the minimum configuration time estimates for Stratix V devices.

| Variant | Member | Active Serial ⁽¹⁾ | | | Fast Passive Parallel ⁽²⁾ | | | |
|---------|----------------|------------------------------|------------|------------------------|--------------------------------------|------------|------------------------|--|
| | Member Code | Width | DCLK (MHz) | Min Config Time (s) | Width | DCLK (MHz) | Min Config Time (s) | |
| | A3 | 4 | 100 | 0.534 | 32 | 100 | 0.067 | |
| | AS | 4 | 100 | 0.344 | 32 | 100 | 0.043 | |
| | A4 | 4 | 100 | 0.534 | 32 | 100 | 0.067 | |
| GX | A5 | 4 | 100 | 0.675 | 32 | 100 | 0.084 | |
| | A7 | 4 | 100 | 0.675 | 32 | 100 | 0.084 | |
| | A9 | 4 | 100 | 0.857 | 32 | 100 | 0.107 | |
| | AB | 4 | 100 | 0.857 | 32 | 100 | 0.107 | |
| | B5 | 4 | 100 | 0.676 | 32 | 100 | 0.085 | |
| | B6 | 4 | 100 | 0.676 | 32 | 100 | 0.085 | |
| | B9 | 4 | 100 | 0.857 | 32 | 100 | 0.107 | |
| | BB | 4 | 100 | 0.857 | 32 | 100 | 0.107 | |
| ст | C5 | 4 | 100 | 0.675 | 32 | 100 | 0.084 | |
| GT | C7 | 4 | 100 | 0.675 | 32 | 100 | 0.084 | |

FPP Configuration Timing when DCLK-to-DATA [] = 1

Figure 12 shows the timing waveform for FPP configuration when using a MAX II or MAX V device as an external host. This waveform shows timing when the DCLK-to-DATA[] ratio is 1.





Notes to Figure 12:

- (1) Use this timing waveform when the DCLK-to-DATA [] ratio is 1.
- (2) The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF_DONE are at logic-high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
- (3) After power-up, the Stratix V device holds nstatus low for the time of the POR delay.
- (4) After power-up, before and during configuration, CONF_DONE is low.
- (5) Do not leave DCLK floating after configuration. DCLK is ignored after configuration is complete. It can toggle high or low if required.
- (6) For FPP ×16, use DATA [15..0]. For FPP ×8, use DATA [7..0]. DATA [31..0] are available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings.
- (7) To ensure a successful configuration, send the entire configuration data to the Stratix V device. CONF_DONE is released high when the Stratix V device receives all the configuration data successfully. After CONF_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
- (8) After the option bit to enable the INIT_DONE pin is configured into the device, the INIT DONE goes low.

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Table 51 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA[] ratio is more than 1.

| Symbol | Parameter | Minimum | Maximum | Units |
|-----------------------------------|---|---|----------------------|-------|
| t _{CF2CD} | nCONFIG low to CONF_DONE low | — | 600 | ns |
| t _{CF2ST0} | nCONFIG low to nSTATUS low | — | 600 | ns |
| t _{CFG} | nCONFIG low pulse width | 2 | _ | μS |
| t _{STATUS} | nSTATUS low pulse width | 268 | 1,506 ⁽²⁾ | μS |
| t _{CF2ST1} | nCONFIG high to nSTATUS high | — | 1,506 ⁽²⁾ | μS |
| t _{CF2CK} ⁽⁵⁾ | nCONFIG high to first rising edge on DCLK | 1,506 | _ | μS |
| t _{ST2CK} ⁽⁵⁾ | nSTATUS high to first rising edge of DCLK | 2 | — | μS |
| t _{DSU} | DATA [] setup time before rising edge on DCLK | 5.5 | | ns |
| t _{DH} | DATA [] hold time after rising edge on DCLK | N-1/f _{DCLK} ⁽⁵⁾ | | S |
| t _{CH} | DCLK high time | $0.45 	imes 1/f_{MAX}$ | | S |
| t _{CL} | DCLK low time | $0.45\times1/f_{MAX}$ | | S |
| t _{CLK} | DCLK period | 1/f _{MAX} | | S |
| f | DCLK frequency (FPP ×8/×16) | — | 125 | MHz |
| f _{MAX} | DCLK frequency (FPP ×32) | — | 100 | MHz |
| t _R | Input rise time | — | 40 | ns |
| t _F | Input fall time | — | 40 | ns |
| t _{CD2UM} | CONF_DONE high to user mode ⁽³⁾ | 175 | 437 | μS |
| t _{CD2CU} | CONF_DONE high to CLKUSR enabled | 4 × maximum DCLK period | _ | _ |
| t _{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | t_{CD2CU} + (8576 × CLKUSR period) ⁽⁴⁾ | _ | _ |

Notes to Table 51:

- (1) Use these timing parameters when you use the decompression and design security features.
- (2) You can obtain this value if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) The minimum and maximum numbers apply only if you use the internal oscillator as the clock source for initializing the device.
- (4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (5) N is the ${\tt DCLK}\mbox{-to-DATA}$ ratio and $f_{{\tt DCLK}}$ is the ${\tt DCLK}$ frequency the system is operating.
- (6) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

| Parameter Available | | Min | Fast | Slow Model | | | | | | | | |
|---------------------|----------|----------------------|------------|------------|-------|-------|-------|-------|-------|-------------|-------|------|
| (1) | Settings | Offset (2) | Industrial | Commercial | C1 | C2 | C3 | C4 | 12 | 13, 13YY | 14 | Unit |
| D3 | 8 | 0 | 1.587 | 1.699 | 2.793 | 2.793 | 2.992 | 3.192 | 2.811 | 3.047 | 3.257 | ns |
| D4 | 64 | 0 | 0.464 | 0.492 | 0.838 | 0.838 | 0.924 | 1.011 | 0.843 | 0.920 | 1.006 | ns |
| D5 | 64 | 0 | 0.464 | 0.493 | 0.838 | 0.838 | 0.924 | 1.011 | 0.844 | 0.921 | 1.006 | ns |
| D6 | 32 | 0 | 0.229 | 0.244 | 0.415 | 0.415 | 0.458 | 0.503 | 0.418 | 0.456 | 0.499 | ns |

Notes to Table 58:

(1) You can set this value in the Quartus II software by selecting D1, D2, D3, D5, and D6 in the Assignment Name column of Assignment Editor.

(2) Minimum offset does not include the intrinsic delay.

Programmable Output Buffer Delay

Table 59 lists the delay chain settings that control the rising and falling edge delays of the output buffer. The default delay is 0 ps.

| Table 55. Flugiallillable Uulput Duffel Delay für Stratix V Devices' | Table 59. |). Programmable Output Buffer Delay for | r Stratix V Devices († |
|--|-----------|---|------------------------|
|--|-----------|---|------------------------|

| Symbol | Parameter | Typical | Unit |
|---------------------|-------------------------------------|-------------|------|
| | | 0 (default) | ps |
| D | Rising and/or falling edge delay | 25 | ps |
| D _{OUTBUF} | | 50 | ps |
| | | 75 | ps |

Note to Table 59:

(1) You can set the programmable output buffer delay in the Quartus II software by setting the Output Buffer Delay Control assignment to either positive, negative, or both edges, with the specific values stated here (in ps) for the Output Buffer Delay assignment.

Glossary

Table 60 lists the glossary for this chapter.

Table 60. Glossary (Part 1 of 4)

| Letter | Subject Definitions | | |
|--------|--|---|--|
| Α | | | |
| В | — | — | |
| С | | | |
| D | _ | _ | |
| E | — | _ | |
| | f _{HSCLK} Left and right PLL input clock frequency. | | |
| F | f _{HSDR} | High-speed I/O block—Maximum and minimum LVDS data transfer rate (f _{HSDR} = 1/TUI), non-DPA. | |
| | f _{hsdrdpa} | High-speed I/O block—Maximum and minimum LVDS data transfer rate (f _{HSDRDPA} = 1/TUI), DPA. | |

| Table 60. | Glossary | (Part 3 of 4) |
|-----------|----------|---------------|
|-----------|----------|---------------|

| Letter | Subject | Definitions | | | | | |
|--------|--|---|--|--|--|--|--|
| | SW (sampling window) | Timing Diagram—the period of time during which the data must be valid in order to capture it correctly. The setup and hold times determine the ideal strobe position within the sampling window, as shown: Bit Time 0.5 x TCCS RSKM Sampling Window RSKM 0.5 x TCCS RSKM | | | | | |
| S | Single-ended voltage referenced I/O standard | The JEDEC standard for SSTL and HSTL I/O defines both the AC and DC input signal values. The AC values indicate the voltage levels at which the receiver must meet its timing specifications. The DC values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input has crossed the AC value, the receiver changes to the new logic state. The new logic state is then maintained as long as the input stays beyond the DC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform ringing: <i>Single-Ended Voltage Referenced I/O Standard</i> | | | | | |
| | t _C | High-speed receiver and transmitter input and output clock period. | | | | | |
| | TCCS (channel- to-channel-skew) The timing difference between the fastest and slowest output edges, including and clock skew, across channels driven by the same PLL. The clock is including measurement (refer to the <i>Timing Diagram</i> figure under SW in this table). | | | | | | |
| | | High-speed I/O block—Duty cycle on the high-speed transmitter output clock. | | | | | |
| т | t _{DUTY} | Timing Unit Interval (TUI) The timing budget allowed for skew, propagation delays, and the data sampling window. (TUI = $1/(\text{receiver input clock frequency multiplication factor}) = t_c/w)$ | | | | | |
| | t _{FALL} | Signal high-to-low transition time (80-20%) | | | | | |
| | t _{INCCJ} | Cycle-to-cycle jitter tolerance on the PLL clock input. | | | | | |
| | t _{OUTPJ_IO} | Period jitter on the general purpose I/O driven by a PLL. | | | | | |
| | t _{outpj_dc} | Period jitter on the dedicated clock output driven by a PLL. | | | | | |
| | t _{RISE} | Signal low-to-high transition time (20-80%) | | | | | |
| U | _ | — | | | | | |

| Letter | Subject | Definitions |
|--------|----------------------|--|
| | V _{CM(DC)} | DC common mode input voltage. |
| | V _{ICM} | Input common mode voltage—The common mode of the differential signal at the receiver. |
| | V _{ID} | Input differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver. |
| | V _{DIF(AC)} | AC differential input voltage—Minimum AC input differential voltage required for switching. |
| | V _{DIF(DC)} | DC differential input voltage— Minimum DC input differential voltage required for switching. |
| | V _{IH} | Voltage input high—The minimum positive voltage applied to the input which is accepted by the device as a logic high. |
| | V _{IH(AC)} | High-level AC input voltage |
| | V _{IH(DC)} | High-level DC input voltage |
| V | V _{IL} | Voltage input low—The maximum positive voltage applied to the input which is accepted by the device as a logic low. |
| | V _{IL(AC)} | Low-level AC input voltage |
| | V _{IL(DC)} | Low-level DC input voltage |
| | V _{OCM} | Output common mode voltage—The common mode of the differential signal at the transmitter. |
| | V _{OD} | Output differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter. |
| | V _{SWING} | Differential input voltage |
| | V _X | Input differential cross point voltage |
| | V _{OX} | Output differential cross point voltage |
| W | W | High-speed I/O block—clock boost factor |
| X | | |
| Y | _ | _ |
| Z | | |

Table 60. Glossary (Part 4 of 4)

Table 61. Document Revision History (Part 2 of 3)

| Date | Version | Changes |
|---------------|---------|---|
| | | Added the I3YY speed grade and changed the data rates for the GX channel in Table 1. |
| | | Added the I3YY speed grade to the V_{CC} description in Table 6. |
| | | Added the I3YY speed grade to V_{CCHIP_L}, V_{CCHIP_R}, V_{CCHSSI_L}, and V_{CCHSSI_R} descriptions in Table 7. |
| | | ■ Added 240-Ω to Table 11. |
| | | Changed CDR PPM tolerance in Table 23. |
| | | Added additional max data rate for fPLL in Table 23. |
| | | Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 25. |
| | | Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 26. |
| | | Changed CDR PPM tolerance in Table 28. |
| | | Added additional max data rate for fPLL in Table 28. |
| | | Changed the mode descriptions for MLAB and M20K in Table 33. |
| | | ■ Changed the Max value of f _{HSCLK_OUT} for the C2, C2L, I2, I2L speed grades in Table 36. |
| November 2014 | 3.3 | Changed the frequency ranges for C1 and C2 in Table 39. |
| | | Changed the .rbf file sizes for 5SGSD6 and 5SGSD8 in Table 47. |
| | | Added note about nSTATUS to Table 50, Table 51, Table 54. |
| | | Changed the available settings in Table 58. |
| | | Changed the note in "Periphery Performance". |
| | | Updated the "I/O Standard Specifications" section. |
| | | Updated the "Raw Binary File Size" section. |
| | | Updated the receiver voltage input range in Table 22. |
| | | Updated the max frequency for the LVDS clock network in Table 36. |
| | | ■ Updated the DCLK note to Figure 11. |
| | | Updated Table 23 VO_{CM} (DC Coupled) condition. |
| | | Updated Table 6 and Table 7. |
| | | ■ Added the DCLK specification to Table 55. |
| | | Updated the notes for Table 47. |
| | | Updated the list of parameters for Table 56. |
| November 2013 | 3.2 | Updated Table 28 |
| November 2013 | 3.1 | Updated Table 33 |
| November 2013 | 3.0 | Updated Table 23 and Table 28 |
| October 2013 | 2.9 | Updated the "Transceiver Characterization" section |
| | 2.8 | Updated Table 3, Table 12, Table 14, Table 19, Table 20, Table 23, Table 24, Table 28, Table 30, Table 31, Table 32, Table 33, Table 36, Table 39, Table 40, Table 41, Table 42, Table 47, Table 53, Table 58, and Table 59 |
| October 2013 | | Added Figure 1 and Figure 3 |
| | | Added the "Transceiver Characterization" section |
| | | Removed all "Preliminary" designations. |

Table 61. Document Revision History (Part 3 of 3)

| Date | Version | Changes |
|------------------|---------|---|
| | | ■ Updated Table 2, Table 6, Table 7, Table 20, Table 23, Table 27, Table 47, Table 60 |
| May 2013 | 2.7 | ■ Added Table 24, Table 48 |
| | | Updated Figure 9, Figure 10, Figure 11, Figure 12 |
| February 2013 | 2.6 | Updated Table 7, Table 9, Table 20, Table 23, Table 27, Table 30, Table 31, Table 35, Table 46 |
| | | Updated "Maximum Allowed Overshoot and Undershoot Voltage" |
| | | Updated Table 3, Table 6, Table 7, Table 8, Table 23, Table 24, Table 25, Table 27, Table 30, Table 32, Table 35 |
| | | Added Table 33 |
| | | Added "Fast Passive Parallel Configuration Timing" |
| December 0010 | 2.5 | Added "Active Serial Configuration Timing" |
| December 2012 | | Added "Passive Serial Configuration Timing" |
| | | Added "Remote System Upgrades" |
| | | Added "User Watchdog Internal Circuitry Timing Specification" |
| | | Added "Initialization" |
| | | Added "Raw Binary File Size" |
| | | Added Figure 1, Figure 2, and Figure 3. |
| June 2012 | 2.4 | Updated Table 1, Table 2, Table 3, Table 6, Table 11, Table 22, Table 23, Table 27, Table 29, Table 30, Table 31, Table 32, Table 35, Table 38, Table 39, Table 40, Table 41, Table 43, Table 56, and Table 59. |
| | | Various edits throughout to fix bugs. |
| | | Changed title of document to Stratix V Device Datasheet. |
| | | Removed document from the Stratix V handbook and made it a separate document. |
| February 2012 | 2.3 | ■ Updated Table 1–22, Table 1–29, Table 1–31, and Table 1–31. |
| December 2011 | 2.2 | ■ Added Table 2–31. |
| | 2.2 | ■ Updated Table 2–28 and Table 2–34. |
| Neurometren 0011 | 0.1 | Added Table 2–2 and Table 2–21 and updated Table 2–5 with information about Stratix V GT devices. |
| November 2011 | 2.1 | Updated Table 2–11, Table 2–13, Table 2–20, and Table 2–25. |
| | | Various edits throughout to fix SPRs. |
| | | Updated Table 2–4, Table 2–18, Table 2–19, Table 2–21, Table 2–22, Table 2–23, and Table 2–24. |
| May 2011 | 2.0 | Updated the "DQ Logic Block and Memory Output Clock Jitter Specifications" title. |
| | | Chapter moved to Volume 1. |
| | | Minor text edits. |
| | 1.1 | ■ Updated Table 1–2, Table 1–4, Table 1–19, and Table 1–23. |
| December 2010 | | Converted chapter to the new template. |
| | | Minor text edits. |
| July 2010 | 1.0 | Initial release. |